# **MOSFET** – N-Channel, SUPERFET<sup>®</sup> II

# 800 V, 46 A, 85 m $\Omega$

# FCH085N80

## Description

SuperFET II MOSFET is ON Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This technology is tailored to minimize conduction loss, provide superior switching performance, dv/dt rate and higher avalanche energy. Consequently, SuperFET II MOSFET is very suitable for the switching power applications such as PFC, server/telecom power, FPD TV power, ATX power and industrial power applications.

## Features

- Typ.  $R_{DS(on)} = 67 \text{ m}\Omega$
- 850 V @  $T_J = 150^{\circ}C$
- Ultra Low Gate Charge (Typ. Q<sub>g</sub> = 196 nC)
- Low E<sub>OSS</sub> (Typ. 18 μJ @ 400 V)
- Low Effective Output Capacitance (Typ. C<sub>oss(eff.)</sub> = 568 pF)
- 100% Avalanche Tested
- These Devices are Pb-Free and are RoHS Compliant

### Applications

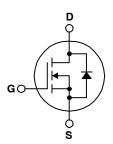
- AC-DC Power Supply
- LED Lighting



# **ON Semiconductor®**

### www.onsemi.com

V <sub>DS</sub>	R <sub>DS(ON)</sub> MAX	I <sub>D</sub> MAX	
800 V	85 mΩ @ 10 V	46 A	

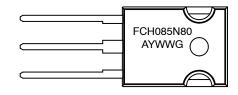


**N-CHANNEL MOSFET** 



TO-247-3LD CASE 340CH

### MARKING DIAGRAM



FCH085N80	= Specific Device Code
А	= Assembly Location
Υ	= Year
WW	= Work Week
G	= Pb-Free Package

#### ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

Symbol	Parameter	Value	Unit	
V <sub>DSS</sub>	Drain to Source Voltage		800	V
V <sub>GSS</sub>	Gate to Source Voltage	– DC	±20	V
		– AC (f > 1 Hz)	±30	
Ι <sub>D</sub>	Drain Current:	– Continuous (T <sub>C</sub> = 25°C)	46	A
		– Continuous (T <sub>C</sub> = 100°C)	29	
I <sub>DM</sub>	Drain Current:	– Pulsed (Note 1)	138	A
E <sub>AS</sub>	Single Pulsed Avalanche Energy (Note 2)		1701	mJ
I <sub>AS</sub>	Avalanche Current (Note 2)		9.2	A
E <sub>AR</sub>	Repetitive Avalanche Energy (Note 1)		4.4	mJ
dv/dt	MOSFET dv/dt		100	V/ns
	Peak Diode Recovery dv/dt (Note 3)		20	
PD	Power Dissipation	(T <sub>C</sub> = 25°C)	446	W
		Derate Above 25°C	3.5	W/°C
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range		-55 to + 150	°C
ΤL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 seconds		300	°C

#### ABSOLUTE MAXIMUM RATINGS (T<sub>C</sub> = 25°C unless otherwise noted)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality shows be assumed, damage may occur and reliability may be affected. 1. Repetitive rating: pulse-width limited by maximum junction temperature. 2.  $I_{AS} = 9.2 \text{ A}, V_{DD} = 50 \text{ V}, R_G = 25 \Omega$ , starting  $T_J = 25 \text{ °C}$ . 3.  $I_{SD} \le 46 \text{ A}, \text{ di/dt} \le 200 \text{ A/}\mu\text{s}, V_{DD} \le \text{BV}_{DSS}$ , starting  $T_J = 25 \text{ °C}$ .

### PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Marking	Package	Packing Method	Reel Size	Tape Width	Quantity
FCH085N80-F155	FCH085N80	TO-247 G03	Tube	N/A	N/A	30 Units

#### **THERMAL CHARACTERISTICS**

Symbol	Parameter	FCH085N80-F155	Unit
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case, Max.	0.28	°C/W
$R_{\thetaJA}$	Thermal Resistance, Junction to Ambient, Max.	40.0	

# **ELECTRICAL CHARACTERISTICS** ( $T_C = 25^{\circ}C$ unless otherwise noted)

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Unit
OFF CHARA	ACTERISTICS	-				
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	$V_{GS}$ = 0 V, $I_D$ = 1 mA, $T_J$ = 25°C	800	-	-	V
$\Delta BV_{DSS}$ / $\Delta T_{J}$	Breakdown Voltage Temperature Coefficient	$I_D = 1$ mA, Referenced to 25°C	-	0.8	-	V/°C
I <sub>DSS</sub>	I <sub>DSS</sub> Zero Gate Voltage Drain Current	$V_{DS} = 800 \text{ V}, V_{GS} = 0 \text{ V}$	_	-	25	μA
		$V_{DS}$ = 640 V, $V_{GS}$ = 0 V, $T_{C}$ = 125 °C	-	-	250	
I <sub>GSS</sub>	Gate to Body Leakage Current	$V_{GS} = \pm 20$ V, $V_{DS} = 0$ V	-	-	±100	nA
ON CHARA	CTERISTICS					
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{GS} = V_{DS}$ , $I_D = 4.6$ mA	2.5	-	4.5	V
R <sub>DS(on)</sub>	Static Drain to Source On Resistance	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 23 \text{ A}$	-	67	85	mΩ
9FS	Forward Transconductance	V <sub>DS</sub> = 20 V, I <sub>D</sub> = 23 A	-	55	-	S
DYNAMIC C	HARACTERISTICS					
C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> = 100 V, V <sub>GS</sub> = 0 V, f = 1 MHz	-	8140	10825	pF
C <sub>oss</sub>	Output Capacitance		-	255	340	pF
C <sub>rss</sub>	Reverse Transfer Capacitance	7	-	10	-	pF
C <sub>oss</sub>	Output Capacitance	$V_{DS}$ = 480 V, $V_{GS}$ = 0 V, f = 1 MHz	-	1000	-	pF
Coss(eff.)	Effective Output Capacitance	$V_{DS}$ = 0 V to 480 V, $V_{GS}$ = 0 V	-	728	-	pF
Q <sub>g(tot)</sub>	Total Gate Charge at 10 V	$V_{DS}$ = 640 V, $I_{D}$ = 46 A, $V_{GS}$ = 10 V	-	196	255	nC
Q <sub>gs</sub>	Gate to Source Gate Charge	(Note 4)	-	40	-	nC
Q <sub>gd</sub>	Gate to Drain "Miller" Charge	7	-	72	-	nC
ESR	Equivalent Series Resistance	f = 1 MHz	-	0.8	-	Ω
SWITCHING	CHARACTERISTICS					
t <sub>d(on)</sub>	Turn-On Delay Time	$V_{DD} = 400 \text{ V}, \text{ I}_{D} = 46 \text{ A},$	-	45	100	ns
t <sub>r</sub>	Turn–On Rise Time	$V_{GS} = 10 \text{ V}, \text{ R}_{g} = 4.7 \Omega$ (Note 4)	-	55	120	ns
t <sub>d(off)</sub>	Turn-Off Delay Time		-	160	330	ns
t <sub>f</sub>	Turn-Off Fall Time		-	35	80	ns
DRAIN-SOU	RCE DIODE CHARACTERISTICS			-	<u> </u>	
I <sub>S</sub>	Maximum Continuous Source to Drain Diode Forward Current			-	46	Α
I <sub>SM</sub>	Maximum Pulsed Drain to Source Diode Forward Current		-	-	138	Α
V <sub>SD</sub>	Drain to Source Diode Forward Voltage	$V_{GS} = 0 V, I_{SD} = 46 A$	-	-	1.2	V
t <sub>rr</sub>	Reverse Recovery Time	$V_{GS} = 0 V, I_{SD} = 46 A,$	-	800	-	ns
Q <sub>rr</sub>	Reverse Recovery Charge	di <sub>F</sub> /dt = 100 A/µs	_	32	_	μC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. Essentially independent of operating temperature typical characteristics.

### **TYPICAL CHARACTERISTICS**

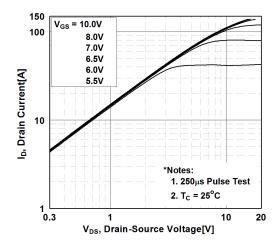


Figure 1. On–Region Characteristics

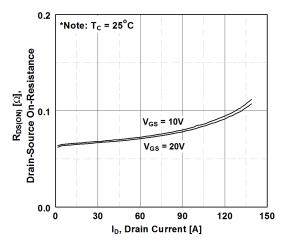
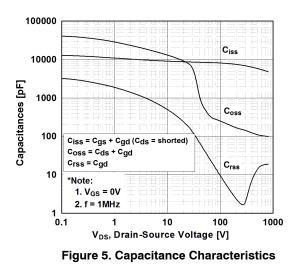
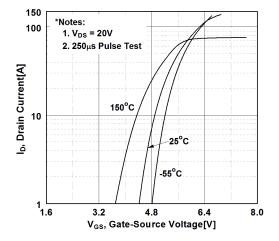


Figure 3. On–Resistance Variation vs. Drain Current and Gate Voltage





**Figure 2. Transfer Characteristics** 

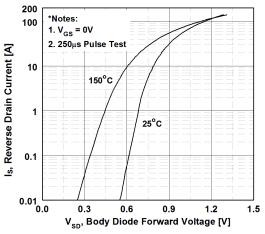


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

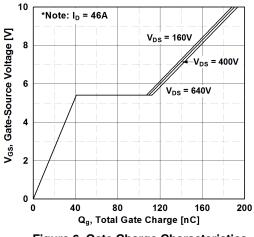


Figure 6. Gate Charge Characteristics

# **TYPICAL CHARACTERISTICS**

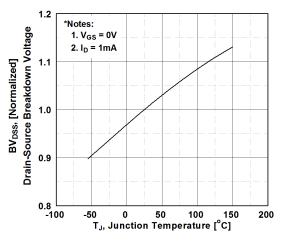


Figure 7. Breakdown Voltage Variation vs. Temperature

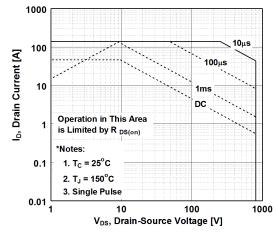


Figure 9. Maximum Safe Operating Area

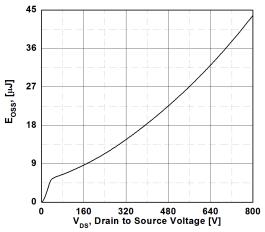
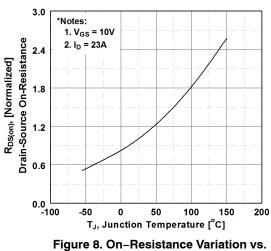
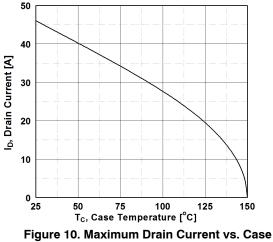


Figure 11. Eoss vs. Drain to Source Voltage



Temperature



igure 10. Maximum Drain Current vs. Case Temperature

# **TYPICAL CHARACTERISTICS**

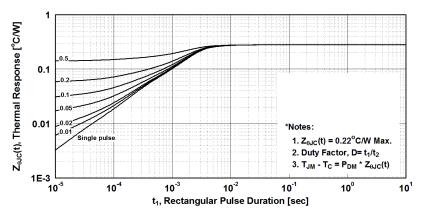
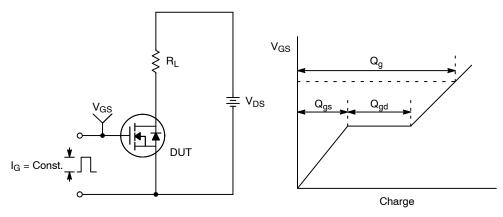


Figure 12. Transient Thermal Response Curve





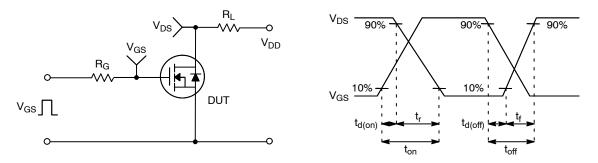


Figure 14. Resistive Switching Test Circuit & Waveforms

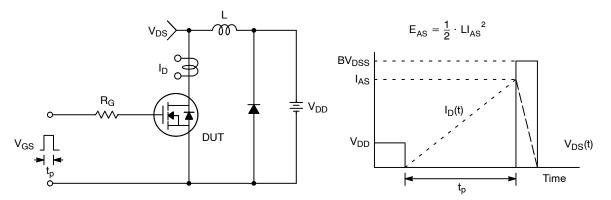


Figure 15. Unclamped Inductive Switching Test Circuit & Waveforms

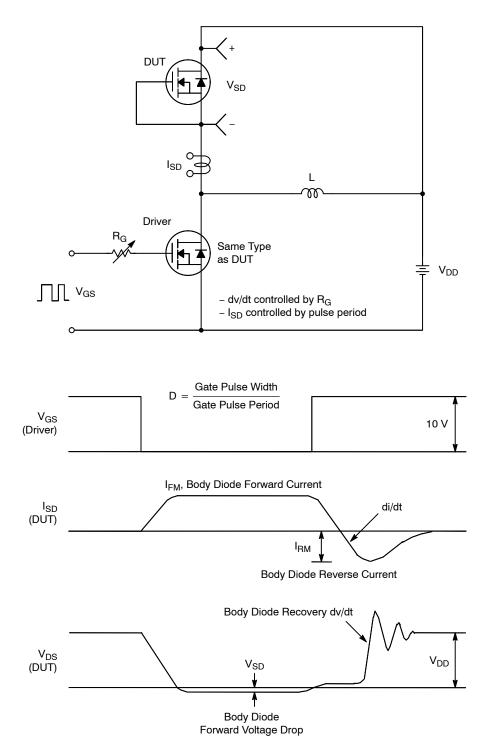
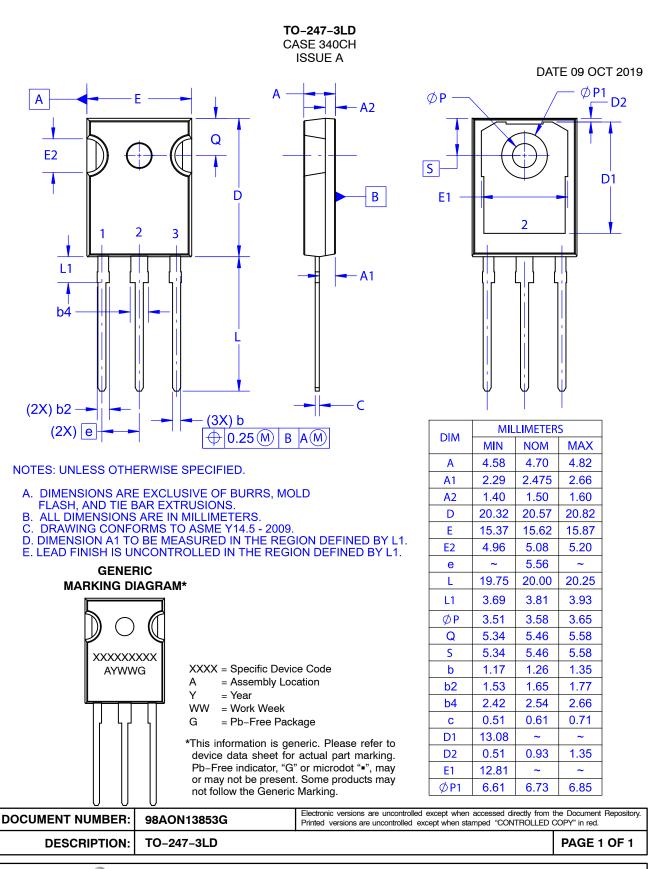


Figure 16. Peak Diode Recovery dv/dt Test Circuit & Waveforms

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